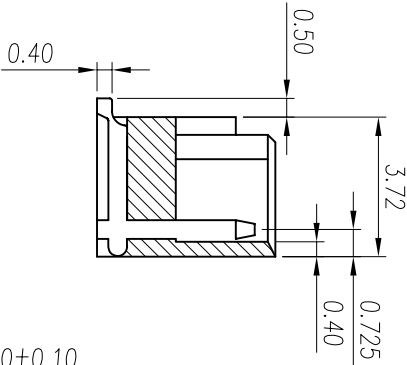
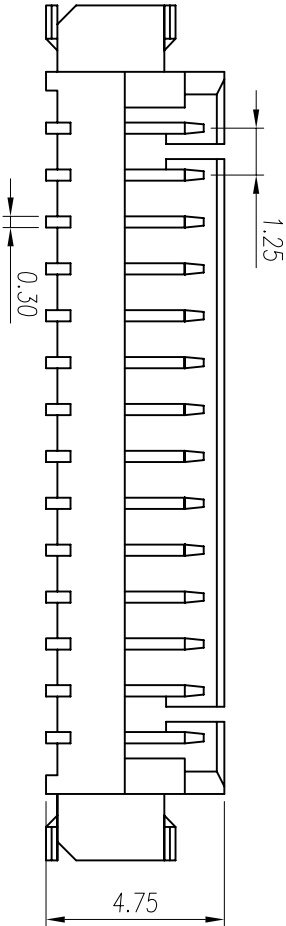
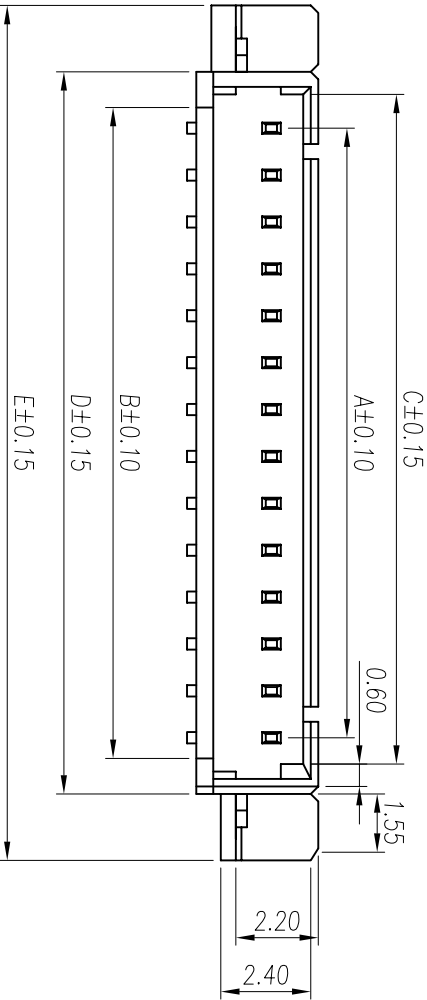


REV.	LOCAS.	DESCRIPTION	DATE	DRAWN
01		INITIAL RELEASE.	2007.09.15	张荣

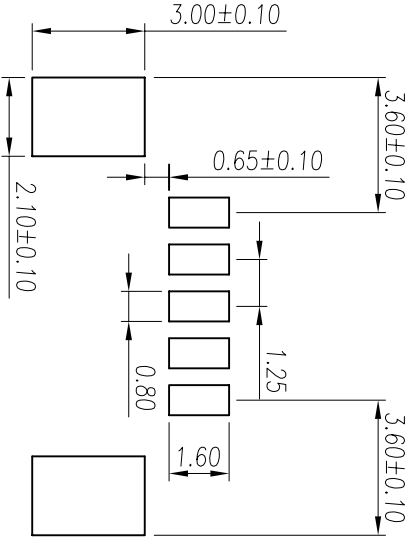
Specifications
Current Rating: 1Amp AC/DC
Insulation Resistance: 100MΩ Min.
Dielectric Withstanding: 100V AC/DC
Contact Resistance: 20mΩ Max.
Operating Temperature:-25°C to +85°C
Withstand Voltage : 500V AC/MINUTE
Material:Nylon 6T UL94V-0
All materials must be GP materials



Circuits	Dim.A	Dim.B	Dim.C	Dim.D	Dim.E
02	1.25	2.35	3.05	4.25	7.79
03	2.50	3.60	4.30	5.50	9.04
04	3.75	4.85	5.55	6.75	10.29
05	5.00	6.10	6.80	8.00	11.54
06	6.25	7.35	8.05	9.25	12.79
07	7.50	8.60	9.30	10.50	14.04
08	8.75	9.85	10.55	11.75	15.29
09	10.00	11.10	11.80	13.00	16.54
10	11.25	12.35	13.05	14.25	17.79
11	12.50	13.60	14.30	15.50	19.04
12	13.75	14.85	15.55	16.75	20.29
13	15.00	16.10	16.80	18.00	21.54
14	16.25	17.35	18.05	19.25	22.79
15	17.50	18.60	19.30	20.50	24.04

Recommended P.C.Board

Hole Layout



Ordering Information

MDS102 - XX XX A01 X

No. of Pins per RowContact Plating Colour
02~15 D=WHITE



深圳市硕康达科技有限公司
Shenzhen Shi Sokcom Technology Co., Ltd

REV.	UNIT.	SCALE.	PAGE.
01	mm	5:1	1/1

GENERAL TOLERANCE		DESIGN:	张荣	DATE:	2007.09.15	DWG. NO.	MDS102-A01	TITLE:	WAFER FOR PITCH
X° ± 5.0°	X. ± 0.30	CHECKED:		DATE:		PART NO.			1.25mm SMT TYPE
.X° ± 3.0°	.X ± 0.25	AUDITED:		DATE:					
.XX° ± 2.0°	.XX ± 0.15	APPROVED:		DATE:					
.XXX ± 1.0°	.XXX ± 0.10								

MDS102- XX XX A01